



## Features

- Lead free as standard
- RoHS compliant\*
- Low profile
- Low power loss, high efficiency
- UL 94V-0 classification

## Applications

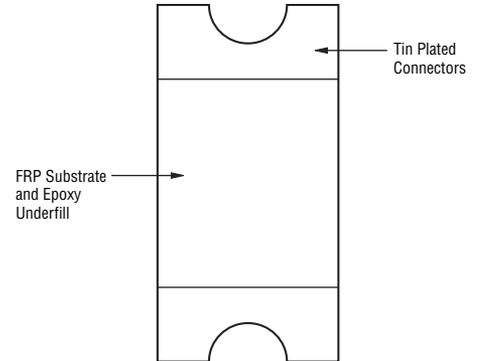
- High frequency switching power supplies
- Inverters
- Free wheeling
- Polarity protection

# CD2010-B140 – Surface Mount Schottky Rectifier Diode

## General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components. Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package 2010 size format, which offers PCB real estate savings and are considerably smaller than most competitive parts. The Schottky Rectifier Diodes offer a forward current of 1 A with a repetitive peak reverse voltage of 40 V.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.



## Electrical Characteristics (@ $T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Min.	Nom.	Max.	Unit
DC Blocking Voltage	$V_{DC}$			40	V
Repetitive Peak Reverse Voltage	$V_{RRM}$			40	V
Average Forward Rectified Current <sup>1</sup>	$I_{(AV)}$			1.0	A
Instantaneous Forward Voltage @ $I_F = 1.0\text{ A}$	$V_F$		0.45	0.55	V
Reverse Leakage Current @ $V_{RRM}$	$I_R$			0.1	mA
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$			70	A

Notes:

1 See Forward Derating Curve.

## Thermal Characteristics (@ $T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

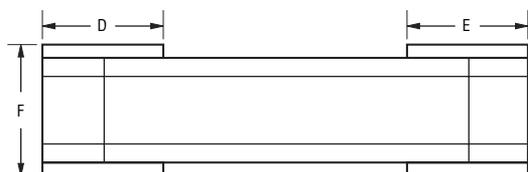
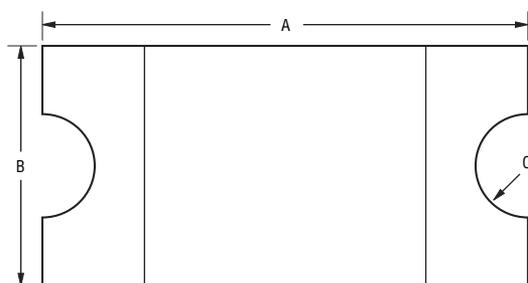
Parameter	Symbol	Min.	Nom.	Max.	Unit
Junction Temperature Range	$T_J$	-40	+25	+125	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-40	+25	+125	$^\circ\text{C}$

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## Product Dimensions

This is a lead free product. It is packaged with FRP substrate and is epoxy underfilled. The terminals are pure tin plated and are solderable per MIL-STD-750, Method 2026. The package weighs approximately 0.02 g. The package and dimensions are shown below.



Dimensions	
A	$\frac{4.40 - 4.60}{(0.173 - 0.181)}$
B	$\frac{2.10 - 2.30}{(0.083 - 0.091)}$
C	$\frac{0.50}{(0.020)}$
D	$\frac{0.75 - 1.15}{(0.029 - 0.045)}$
E	$\frac{0.75 - 1.15}{(0.029 - 0.045)}$
F	$\frac{0.85 - 1.25}{(0.033 - 0.049)}$

DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

## Recommended Footprint

The device will mount onto existing JEDEC SOD-106 footprint.

## How To Order

**CD 2010 - B 1 40**

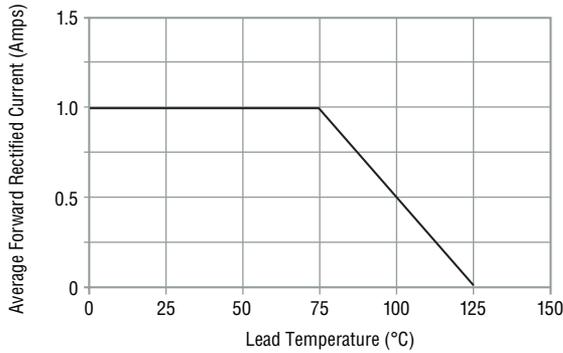
Common Code \_\_\_\_\_  
 Chip Diode \_\_\_\_\_  
 Package \_\_\_\_\_  
 • 2010 \_\_\_\_\_  
 Model \_\_\_\_\_  
 B = Schottky Barrier Diode \_\_\_\_\_  
 Current \_\_\_\_\_  
 1 = 1 A \_\_\_\_\_  
 Working Peak Reverse Voltage \_\_\_\_\_  
 40 = 40 V<sub>RWM</sub> (Volts) \_\_\_\_\_

# CD2010-B140 – Surface Mount Schottky Rectifier Diode

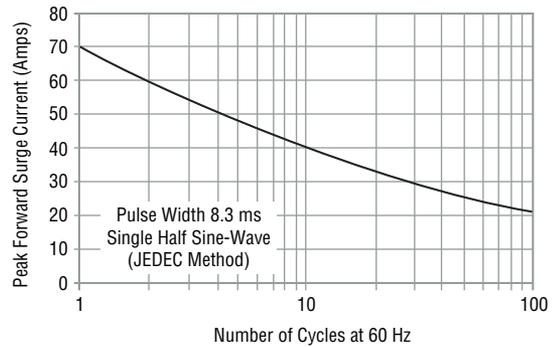


## Rating and Characteristic Curves

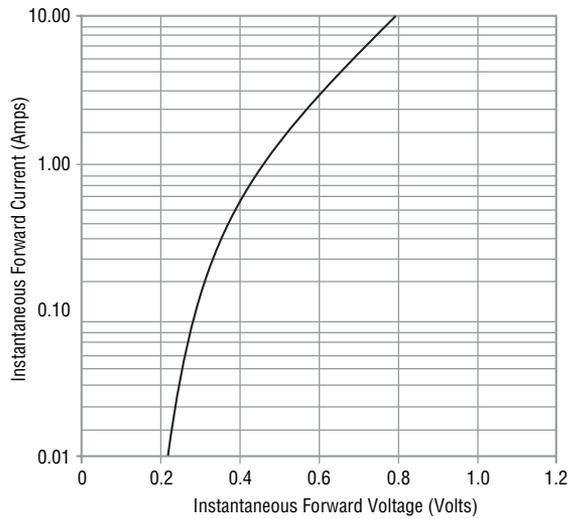
### Forward Current Derating Curve



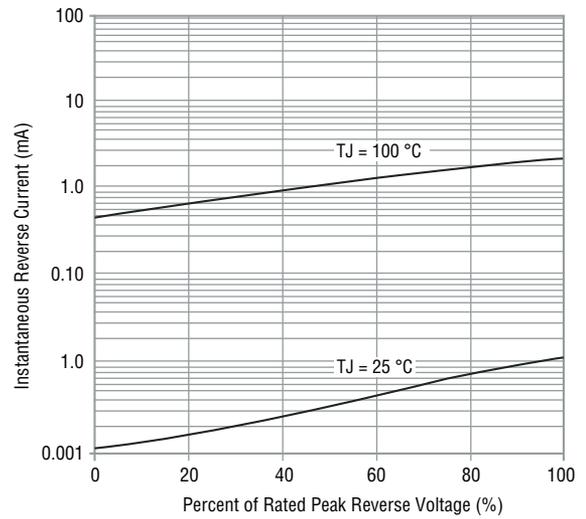
### Maximum Non-Repetitive Peak Forward Surge Current



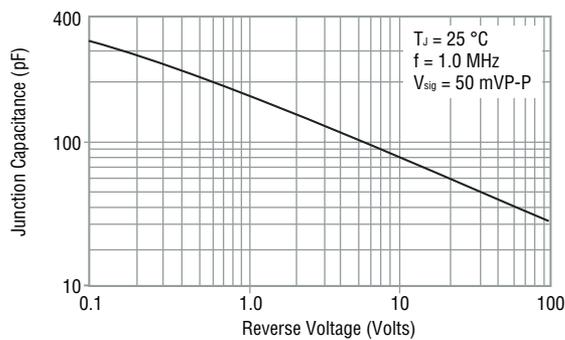
### Forward Characteristics



### Reverse Characteristics



### Typical Junction Capacitance



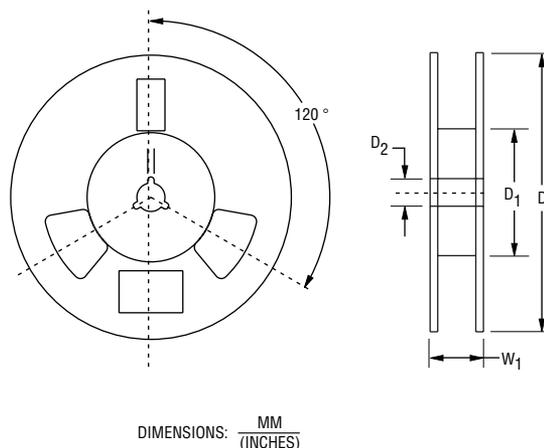
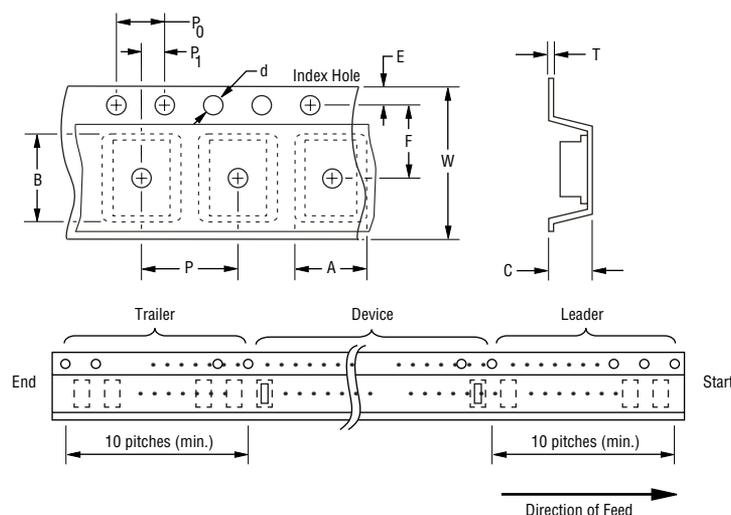
\*RoHS Directive 2002/95/EC Jan 27 2003 including Annex  
 Specifications are subject to change without notice.  
 Customers should verify actual device performance in their specific applications.

# CD2010-B140 – Surface Mount Schottky Rectifier Diode

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## Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).



Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

Item	Symbol	2010
Carrier Width	A	$\frac{2.80 \pm 0.10}{(0.110 \pm 0.004)}$
Carrier Length	B	$\frac{5.00 \pm 0.10}{(0.197 \pm 0.004)}$
Carrier Depth	C	$\frac{1.55 \pm 0.10}{(0.061 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{178}{(7.008)}$
Reel Inner Diameter	D <sub>1</sub>	$\frac{80.0}{(3.150)}$ Min.
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 \pm 0.008)}$
Reel Width	W <sub>1</sub>	$\frac{13.5}{(0.531)}$ Max.
Quantity per Reel	—	2,500



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